

## Description

The PSM8N03R2 uses split gate trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge. This device is suitable for power management and high efficiency applications at high switching frequencies applications.

### MOSFET Product Summary

$V_{DS}(V)$	$R_{DS(on)}(m\Omega)(Typ)$	$I_D(A)$
30	1.3@ $V_{GS} = 10V$	181
	2.3@ $V_{GS} = 4.5V$	

## Feature

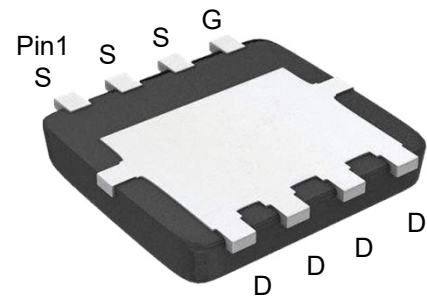
- Low  $R_{DS(ON)}$  - Ensures On-State Losses are Minimized
- Excellent  $Q_{gd} \times R_{DS(ON)}$  Product(FOM)
- Advanced Technology for DC-DC Converts
- Small Form Factor Thermally Efficient Package  
Enables Higher Density End Products
- 100% UIS (Avalanche) Rated
- Lead-Free Finish ; RoHS Compliant
- Halogen and Antimony Free. "Green" Device

## Applications

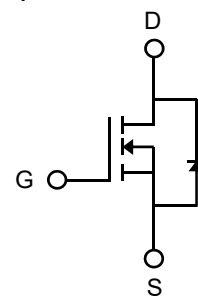
- PWM applications
- Load switch
- Power management
- DC-DC Converters
- Wireless Chargers

## Absolute maximum rating@25°C

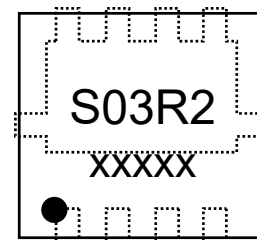
Rating	Symbol	Value	Units
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous <sup>1)</sup>	$I_D$	$T_C=25^\circ C$	181
		$T_C=100^\circ C$	114
Pulsed Drain Current <sup>2)</sup>	$I_{DM}$	724	A
Total Power Dissipation <sup>4)</sup>	$P_D$	$T_C=25^\circ C$	78
		$T_C=100^\circ C$	31
Avalanche Current @ $L=0.3mH$	$I_{AS}$	28	A
Avalanche Energy @ $L=0.3mH$	$E_{AS}$	117	mJ
Thermal Resistance , Junction-to-Case <sup>4)</sup>	$R_{\theta JC}$	1.6	$^\circ C/W$
Thermal Resistance Junction-to-Ambient <sup>3)</sup>	$R_{\theta JA}$	42	$^\circ C/W$
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55~+150	$^\circ C$



PDFN5060-8L  
(Bottom View)



Circuit Diagram



Pin1

Marking (Top View)

## Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units	
<b>Off Characteristics</b>							
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30	-	-	V	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 30V, V_{GS} = 0V$	$T_J = 25^\circ C$	-	-	1.0	$\mu A$
			$T_J = 55^\circ C$	-	-	10	
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	$\pm 100$	nA	
<b>On Characteristics<sup>5)</sup></b>							
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.2	1.7	2.5	V	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 20A$	-	1.3	1.6	m $\Omega$	
		$V_{GS} = 4.5V, I_D = 15A$	-	2.3	2.7		
Forward Transconductance	$g_{fs}$	$V_{DS} = 5V, I_D = 20A$	-	33	-	S	
Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0V, I_S = 2A$	-	0.7	1.2	V	
<b>Dynamic Characteristics<sup>6)</sup></b>							
Input Capacitance	$C_{iss}$	$V_{DS} = 15V, V_{GS} = 0V, f = 1.0MHz$	-	2517	-	pF	
Output Capacitance	$C_{oss}$		-	1731	-		
Reverse Transfer Capacitance	$C_{rss}$		-	142	-		
<b>Switching Characteristics<sup>6)</sup></b>							
Turn-on Delay Time	$t_{d(on)}$	$V_{DS} = 15V, V_{GS} = 10V, I_D = 20A, R_{GEN} = 3\Omega$	-	5.4	-	ns	
Turn-on Rise Time	$t_r$		-	11	-		
Turn-Off Delay Time	$t_{d(off)}$		-	29	-		
Turn-Off Fall Time	$t_f$		-	12	-		
Total Gate Charge	$Q_g$	$V_{DS} = 15V, V_{GS} = 0 \text{ to } 10V, I_D = 20A$	-	39	-	nC	
Gate-Source Charge	$Q_{gs}$		-	7.2	-		
Gate-Drain Charge	$Q_{gd}$		-	7.4	-		
Gate Resistance	$R_g$	$V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$	-	1.3	-	$\Omega$	
<b>Drain-Source Diode Characteristics</b>							
Diode Forward Current	$I_S$	-	-	-	181	A	
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F = 20A, d_i/d_t = 100A/\mu s$	-	46	-	ns	
Body Diode Reverse Recovery Charge	$Q_{rr}$		-	37	-	nC	

## Notes:

- Pulse width limited by maximum junction temperature.
- Pulse test : Pulse width  $\leq 100\mu s$ , duty cycle  $\leq 2\%$ .
- Device mounted on 1 inch FR4 PCB with 2oz.Copper.
- Device mounted on infinite heatsink.
- Measured under pulsed conditions. Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
- Guaranteed by design, not subject to production.

Typical Characteristics

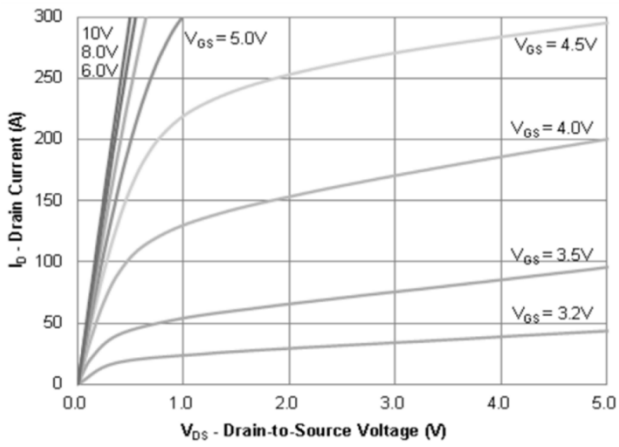


Figure 1: Output Characteristics

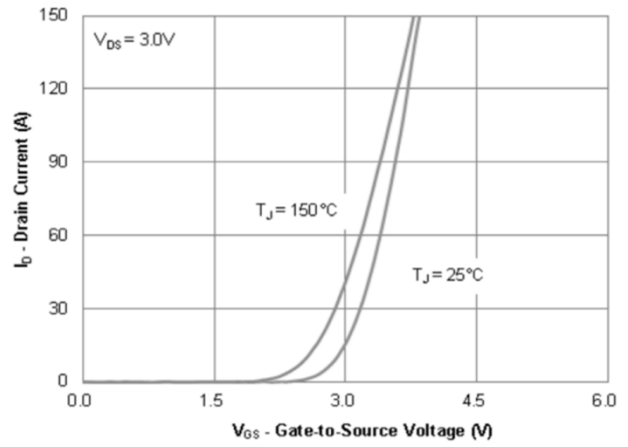


Figure 2: Transfer Characteristics

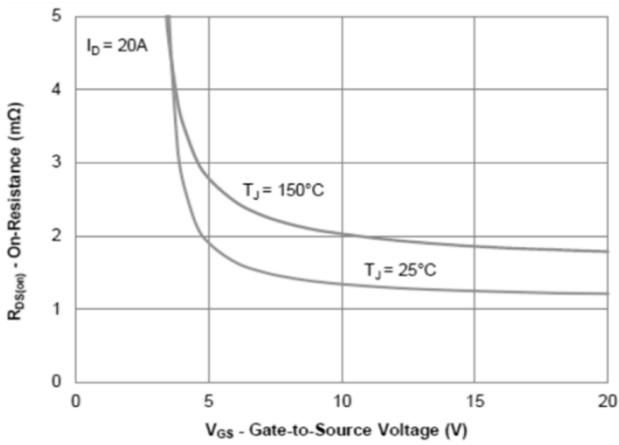


Figure 3: On-Resistance vs. Gate-Source Voltage

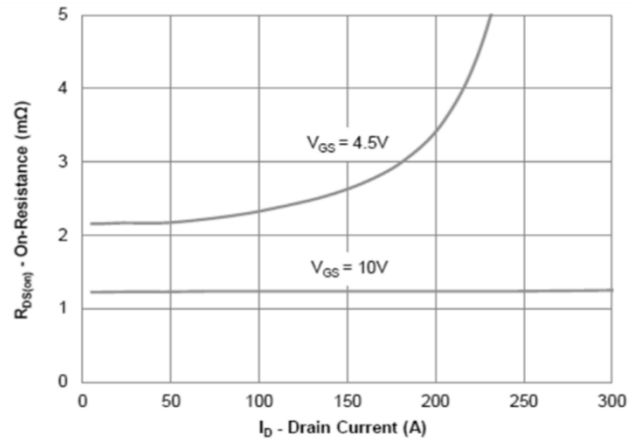


Figure 4: On-Resistance vs. Drain Current

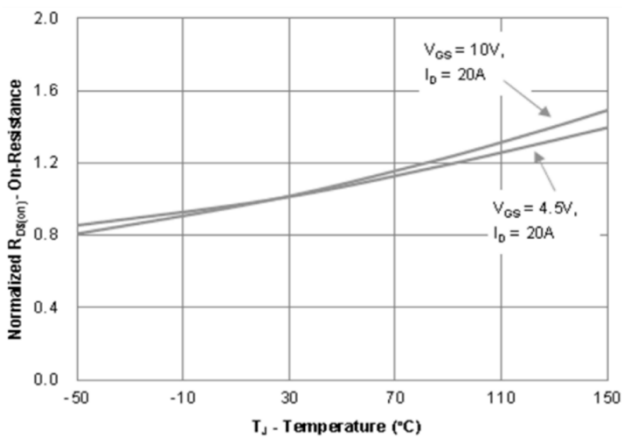


Figure 5: On-Resistance vs. Junction Temperature

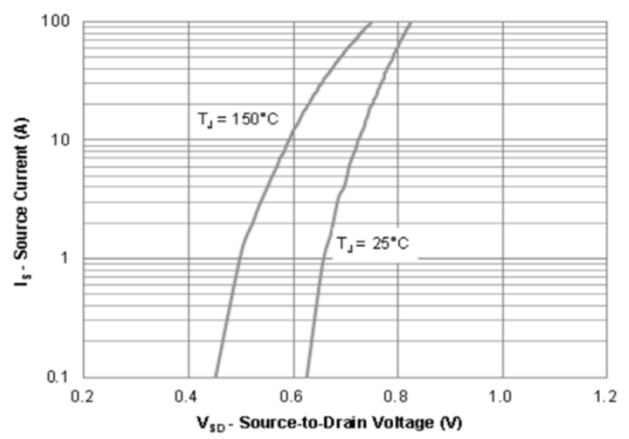


Figure 6: Source-Drain Diode Forward Voltage

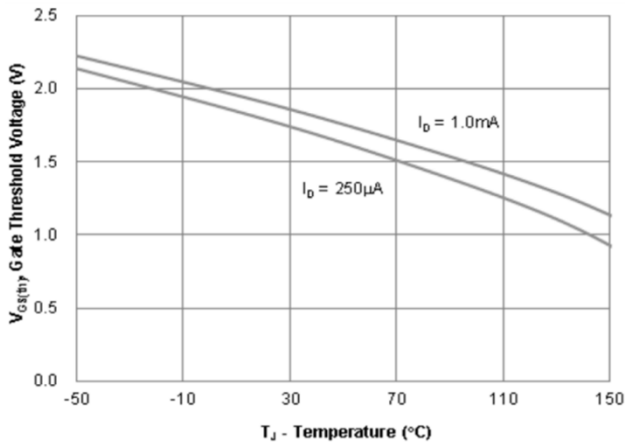


Figure 7: Gate Threshold Variation vs. Junction Temperature

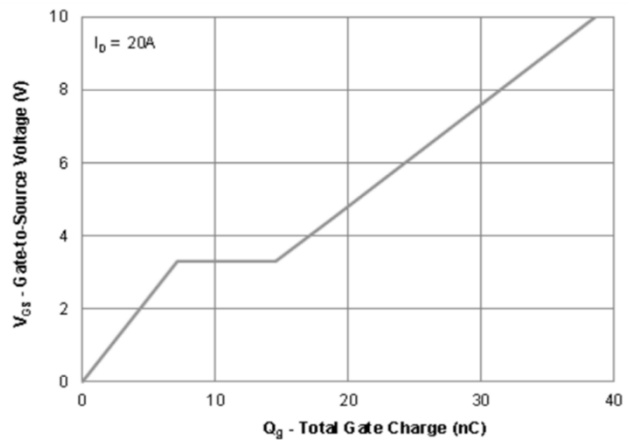


Figure 8: Gate Charge Characteristics

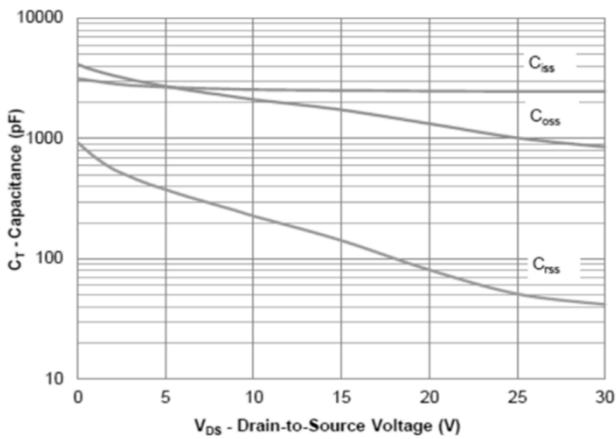


Figure 9: Capacitance Characteristics

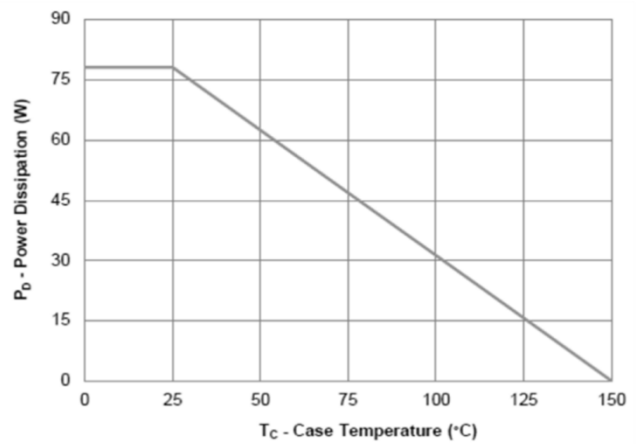


Figure 10: Power Derating

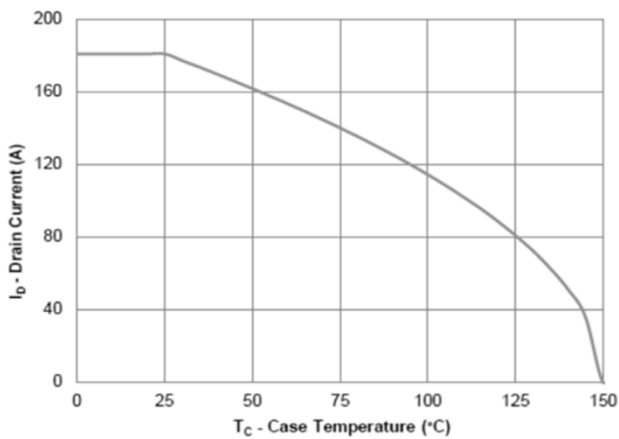


Figure 11: Current Derating

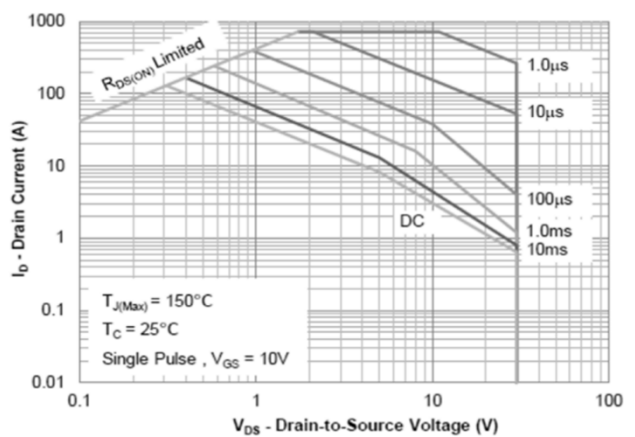


Figure 12: Safe Operating Area

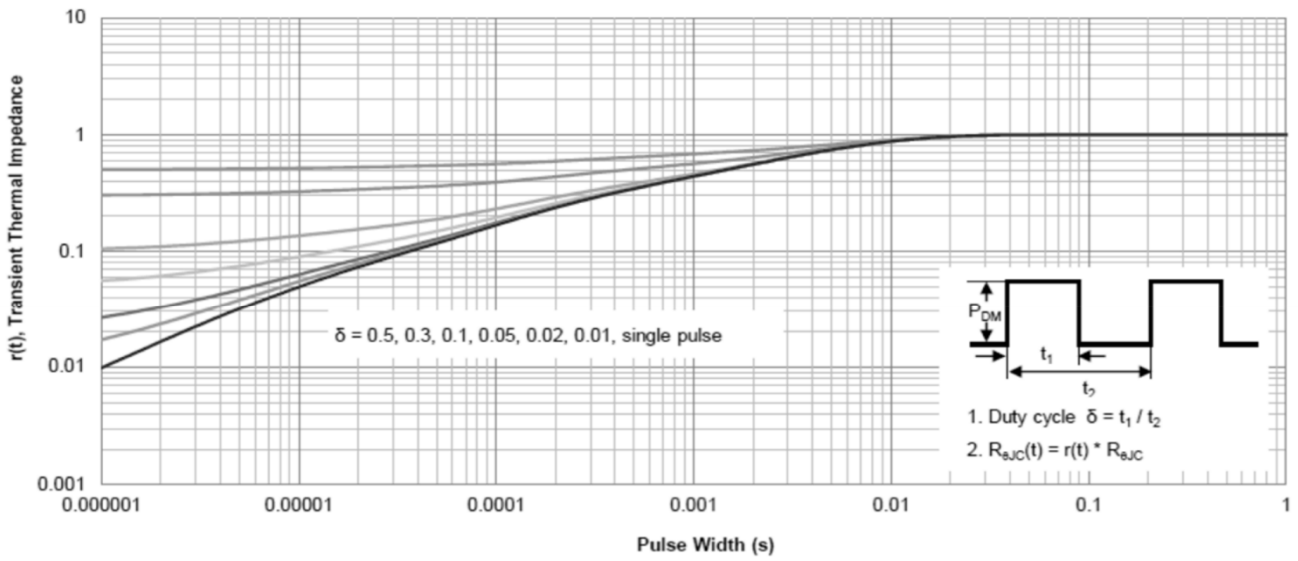
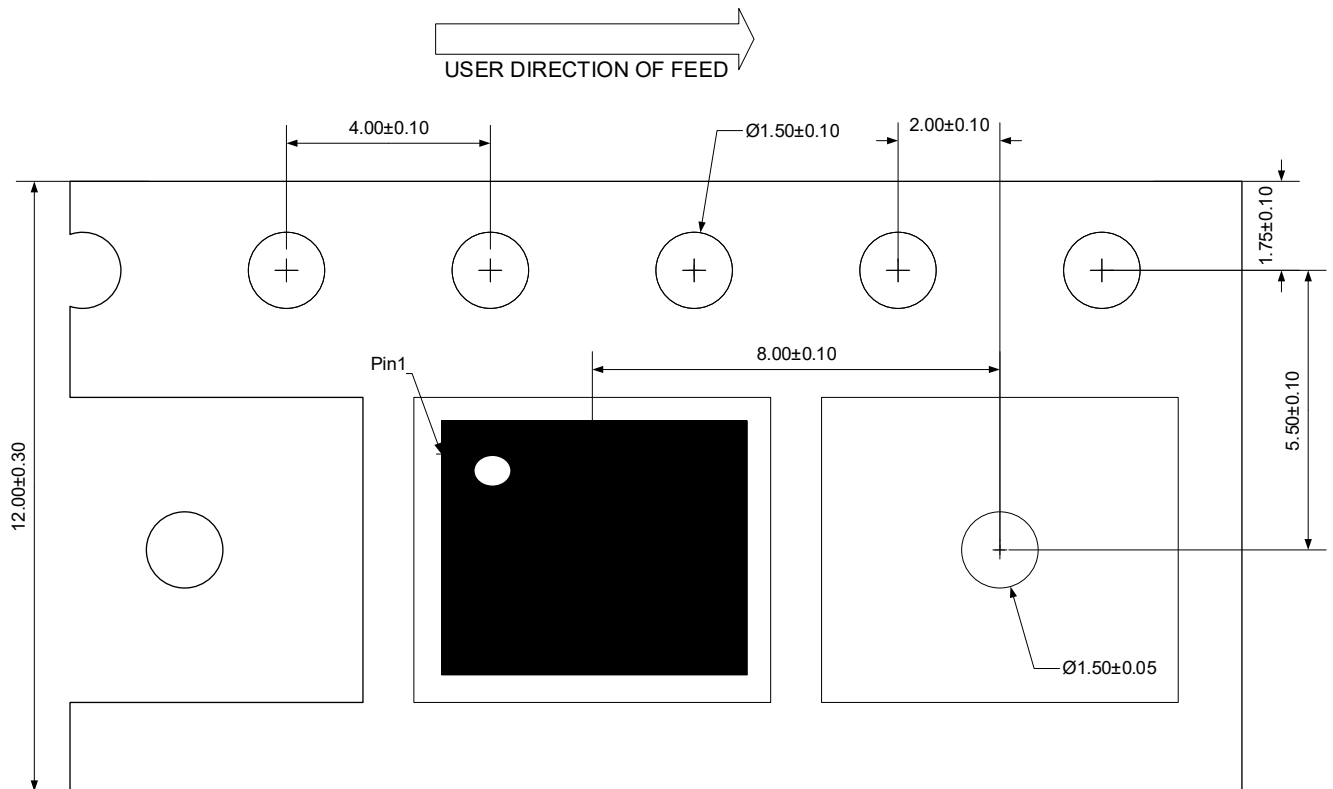


Figure 13: Normalized Maximum Transient Thermal Impedance

Ordering Information

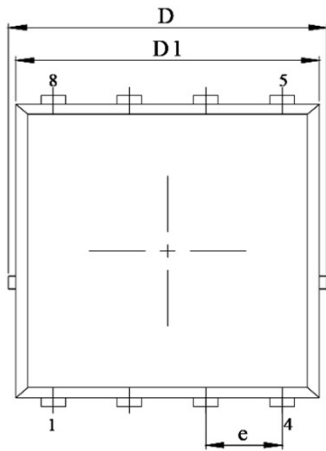
Device	Package	Reel	Shipping
PSM8N03R2	PDFN5060-8L	13"	5000 / Tape & Reel

Load With Information

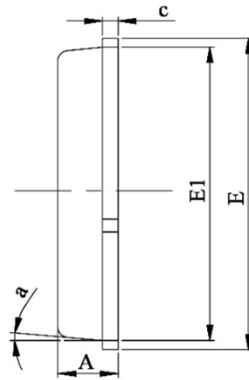


Unit:mm

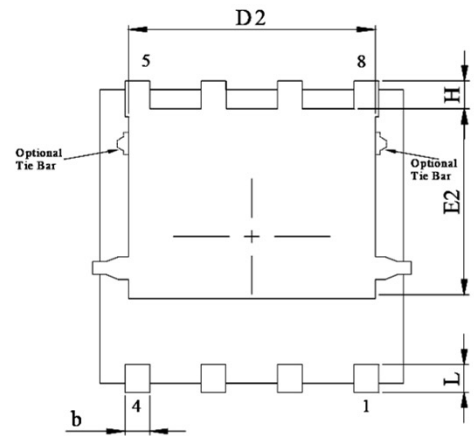
## Product Dimension (PDFN5060-8L)



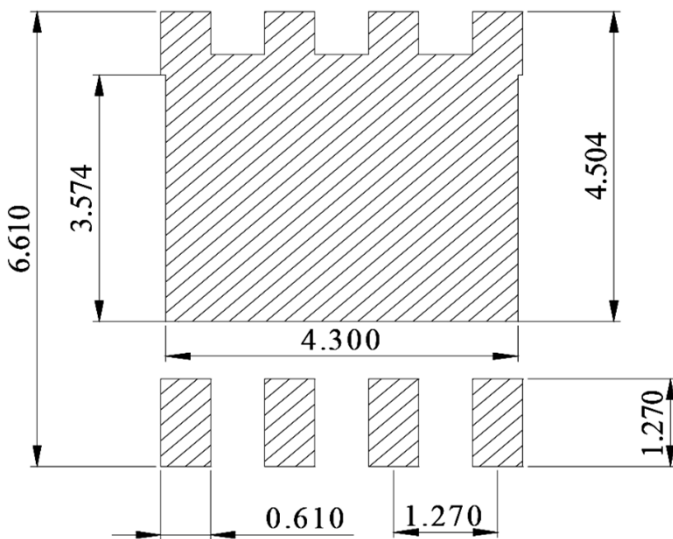
Top View



Side View



Bottom View



Unit: mm

Suggested PCB Layout

Dim	Millimeters		Inches	
	Min	Max	Min	Max
A	0.90	1.10	0.035	0.043
b	0.20	0.51	0.008	0.020
c	0.21	0.34	0.008	0.013
D	4.90	5.40	0.193	0.213
D1	4.80	5.15	0.189	0.203
D2	3.91	4.20	0.154	0.165
E	5.90	6.50	0.232	0.256
E1	5.65	5.95	0.222	0.234
E2	3.32	3.63	0.131	0.143
e	1.27 BSC.		0.050 Ref.	
H	0.50	0.93	0.020	0.037
L	0.45	0.91	0.018	0.036
a	0°	12°	0°	12°

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